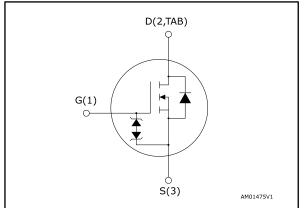


Datasheet - production data

N-channel 600 V, 0.95 Ω typ., 5 A MDmesh[™] DM2 Power MOSFET in a DPAK package

TAB 2 3 1 DPAK

Figure 1: Internal schematic diagram



This is information on a product in full production.

Features

| Order code | VDS | R _{DS(on)} max. | ΙD | Ртот |
|------------|-------|--------------------------|-----|------|
| STD6N60DM2 | 600 V | 1.10 Ω | 5 A | 60 W |

- Fast-recovery body diode
- Extremely low gate charge and input capacitance
- Low on-resistance
- 100% avalanche tested
- Extremely high dv/dt ruggedness
- Zener-protected

Applications

• Switching applications

Description

This high voltage N-channel Power MOSFET is part of the MDmeshTM DM2 fast recovery diode series. It offers very low recovery charge (Qrr) and time (trr) combined with low $R_{DS(on)}$, rendering it suitable for the most demanding high efficiency converters and ideal for bridge topologies and ZVS phase-shift converters.

Table 1: Device summary

| Order code | Marking | Package | Packing |
|------------|---------|---------|---------------|
| STD6N60DM2 | 6N60DM2 | DPAK | Tape and reel |

Contents

Contents

| 1 | Electric | al ratings | |
|---|----------|--|----|
| 2 | Electric | al characteristics | 4 |
| | 2.1 | Electrical characteristics (curves) | 6 |
| 3 | Test cir | cuits | 8 |
| 4 | Packag | e information | 9 |
| | 4.1 | DPAK (TO-252) type A package information | 9 |
| | 4.2 | DPAK (TO-252) type C package information | 12 |
| | 4.3 | DPAK (TO-252) packing information | 15 |
| 5 | Revisio | n history | 17 |



1 Electrical ratings

 Table 2: Absolute maximum ratings

| Symbol | Parameter | Value | Unit |
|----------------------|--|------------|------|
| Vgs | Gate-source voltage | ±25 | V |
| I | Drain current (continuous) at T _{case} = 25 °C | 5 | А |
| ID | Drain current (continuous) at T _{case} = 100 °C | 3.2 | A |
| IDM ⁽¹⁾ | Drain current (pulsed) | 20 | А |
| P _{TOT} | Total dissipation at T _{case} = 25 °C | 60 | W |
| dv/dt ⁽²⁾ | Peak diode recovery voltage slope | 50 | V/ns |
| dv/dt ⁽³⁾ | MOSFET dv/dt ruggedness | 50 | |
| T _{stg} | Storage temperature range | | °C |
| Tj | Operating junction temperature range | -55 to 150 | U U |

Notes:

 $^{\left(1\right) }$ Pulse width is limited by safe operating area.

 $^{(2)}$ I_{SD} ≤ 5 A, di/dt = 900 A/µs; V_{DS} peak < V_{(BR)DSS}, V_DD = 480 V.

 $^{(3)}$ V_{DS} \leq 480 V.

Table 3: Thermal data

| Symbol | Parameter | Value | Unit |
|-------------------------|---|-------|---------|
| Rthj-case | Thermal resistance junction-case | 2.08 | °C A.V. |
| Rthj-pcb ⁽¹⁾ | Rthj-pcb ⁽¹⁾ Thermal resistance junction-pcb | | °C/W |

Notes:

 $^{(1)}$ When mounted on a 1-inch² FR-4, 2 Oz copper board.

Table 4: Avalanche characteristics

| Symbol | Parameter | Value | Unit |
|--------------------------------|---|-------|------|
| I _{AR} ⁽¹⁾ | Avalanche current, repetitive or not repetitive | 1.7 | А |
| E _{AS} ⁽²⁾ | Single pulse avalanche energy | 132 | mJ |

Notes:

 $^{\left(1\right) }$ Pulse width limited by $T_{jmax}.$

 $^{(2)}$ Starting T_j = 25 °C, I_D = I_{AR}, V_{DD} = 50 V.



2 Electrical characteristics

(T_{case} = 25 °C unless otherwise specified)

| Symbol | Parameter | Test conditions | Min. | Тур. | Max. | Unit |
|---|--------------------------------------|--|------|------|------|------|
| V _{(BR)DSS} | Drain-source breakdown voltage | $V_{GS} = 0 V$, $I_D = 1 mA$ | 600 | | | V |
| | | $V_{GS} = 0 V, V_{DS} = 600 V$ | | | 1 | |
| I _{DSS} Zero gate voltage d current | 0 0 | $V_{GS} = 0 V, V_{DS} = 600 V,$ $T_{case} = 125 °C (1)$ | | | 100 | μA |
| lgss | Gate-body leakage current | $V_{DS} = 0 V$, $V_{GS} = \pm 25 V$ | | | ±5 | μA |
| V _{GS(th)} | Gate threshold voltage | $V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$ | 3.25 | 4 | 4.75 | V |
| R _{DS(on)} | Static drain-source on-resistance | $V_{\text{GS}} = 10 \text{ V}, \text{ I}_{\text{D}} = 2.5 \text{ A}$ | | 0.95 | 1.10 | Ω |

Notes:

⁽¹⁾Defined by design, not subject to production test.

| Symbol | Parameter | Test conditions | Min. | Тур. | Max. | Unit |
|-------------------------|---------------------------------|--|------|------|------|------|
| Ciss | Input capacitance | | - | 274 | - | |
| Coss | Output capacitance | $V_{DS} = 100 V, f = 1 MHz,$ | - | 15 | - | рF |
| C _{rss} | Reverse transfer capacitance | V _{GS} = 0 V | - | 2 | - | Ρ. |
| Coss eq. ⁽¹⁾ | Equivalent output capacitance | V_{DS} = 0 to 480 V, V_{GS} = 0 V | - | 25 | - | pF |
| R _G | Intrinsic gate resistance | f = 1 MHz, I _D = 0 A | - | 6.5 | - | Ω |
| Qg | Total gate charge | $V_{DD} = 480 \text{ V}, \text{ I}_{D} = 5 \text{ A},$ | - | 8.6 | - | |
| Qgs | Gate-source charge | V _{GS} = 0 to 10 V | - | 2 | - | nC |
| Q _{gd} | Gate-drain charge | (see Figure 15: "Test circuit for gate charge behavior") | - | 5.2 | - | |

Table 6: Dynamic

Notes:

 $^{(1)}$ Coss eq. is defined as a constant equivalent capacitance giving the same charging time as Coss when VDS increases from 0 to 80% VDSS.

| Symbol | Parameter | Test conditions | Min. | Тур. | Max. | Unit | |
|---------------------|---------------------|---|------|------|------|------|--|
| t _{d(on)} | Turn-on delay time | $V_{DD} = 300 \text{ V}, \text{ I}_{D} = 2.5 \text{ A}$ | - | 9.2 | - | | |
| tr | Rise time | $R_{G} = 4.7 \Omega, V_{GS} = 10 V$ | - | 5.6 | - | | |
| t _{d(off)} | Turn-off delay time | (see Figure 14: "Test circuit for resistive load switching times" | - | 12 | - | ns | |
| tr | Fall time | and Figure 19: "Switching time waveform") | - | 19.6 | - | | |

Table 7: Switching times

4/18



Electrical characteristics

| | Table 8: Source-drain diode | | | | | | | | |
|---------------------------------|-------------------------------|--|------|------|------|------|--|--|--|
| Symbol | Parameter | Test conditions | Min. | Тур. | Max. | Unit | | | |
| Isd | Source-drain current | | - | | 5 | А | | | |
| I _{SDM} ⁽¹⁾ | Source-drain current (pulsed) | | - | | 20 | А | | | |
| Vsd ⁽²⁾ | Forward on voltage | $V_{GS} = 0 V$, $I_{SD} = 5 A$ | - | | 1.6 | V | | | |
| trr | Reverse recovery time | I _{SD} = 5 A, di/dt = 100 A/µs, | | 60 | | ns | | | |
| Qrr | Reverse recovery charge | V _{DD} = 60 V (see Figure 16: "Test circuit for | - | 135 | | nC | | | |
| I _{RRM} | Reverse recovery current | inductive load switching and diode - recovery times") | | 4.5 | | А | | | |
| trr | Reverse recovery time | $I_{SD} = 5 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s},$ | - | 132 | | ns | | | |
| Qrr | Reverse recovery charge | $V_{DD} = 60 \text{ V}, \text{ T}_{j} = 150 \text{ °C}$ (see Figure 16: "Test circuit for inductive load switching and diode | - | 429 | | nC | | | |
| I _{RRM} | Reverse recovery current | recovery times") | - | 6.5 | | А | | | |

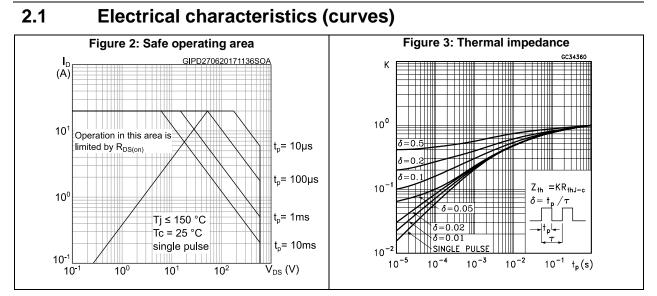
Notes:

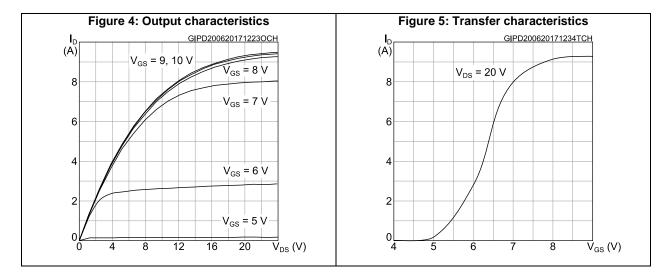
 $^{\left(1\right) }$ Pulse width is limited by safe operating area.

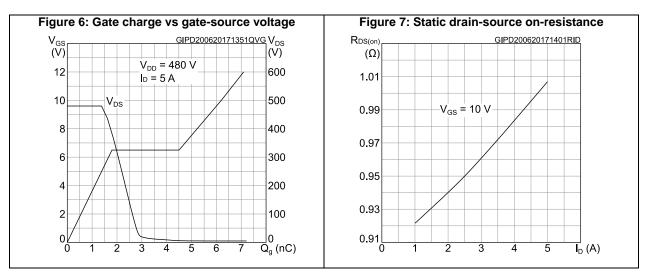
 $^{(2)}$ Pulse test: pulse duration = 300 $\mu s,$ duty cycle 1.5%.







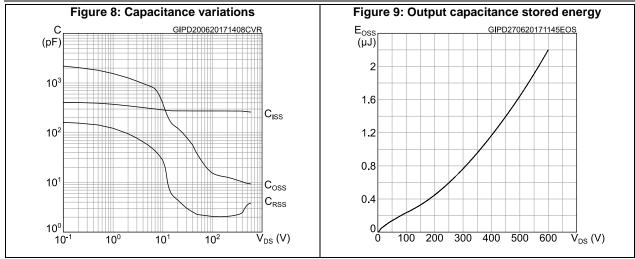


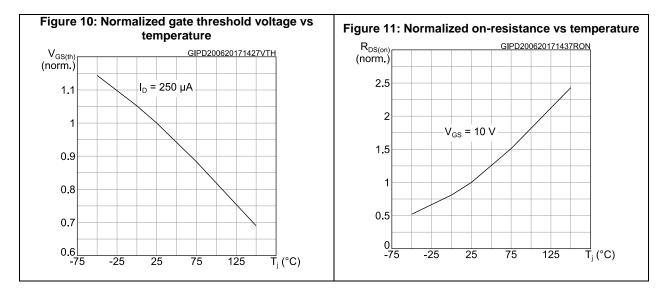


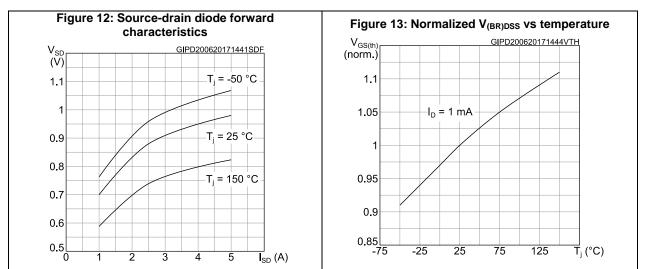
6/18



Electrical characteristics



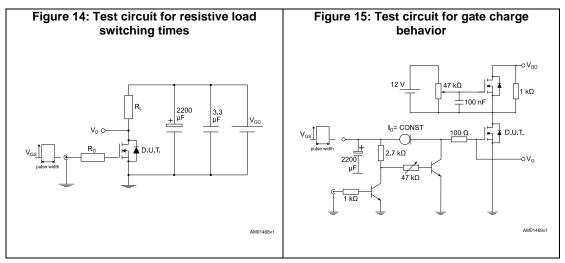


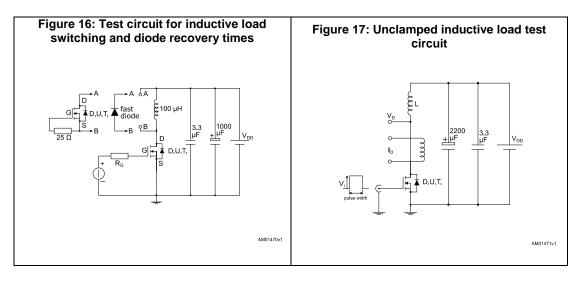


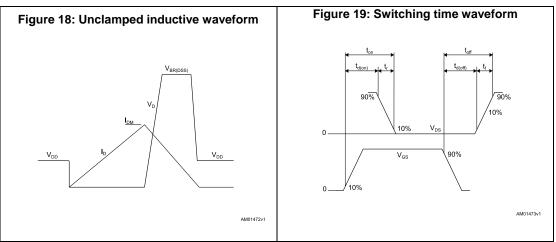
DocID030757 Rev 1

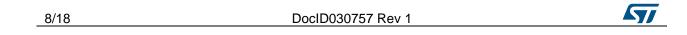
57

3 Test circuits





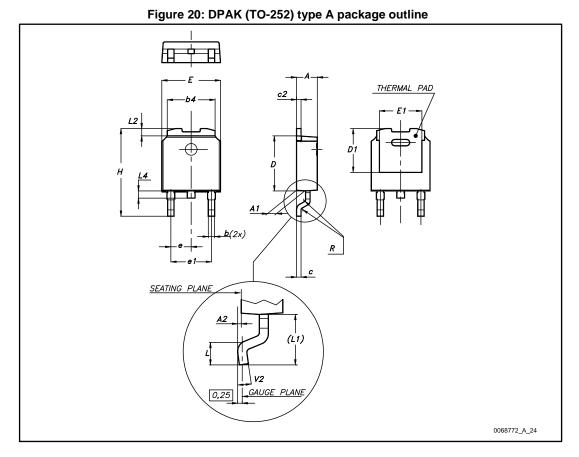




4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.

4.1 DPAK (TO-252) type A package information



57

Package information

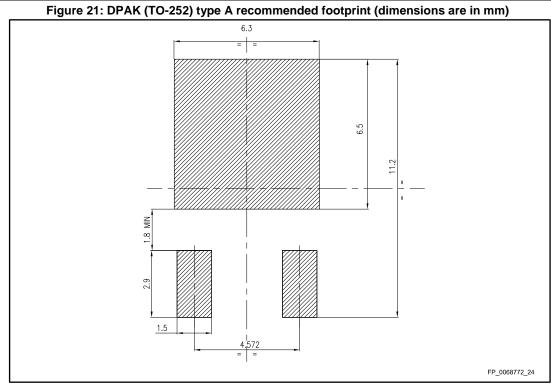
STD6N60DM2

| Table 9: DPAK (TO-252) type A mechanical data | | | | | |
|---|------|------|-------|--|--|
| D 1 | | mm | | | |
| Dim. | Min. | Тур. | Max. | | |
| Α | 2.20 | | 2.40 | | |
| A1 | 0.90 | | 1.10 | | |
| A2 | 0.03 | | 0.23 | | |
| b | 0.64 | | 0.90 | | |
| b4 | 5.20 | | 5.40 | | |
| С | 0.45 | | 0.60 | | |
| c2 | 0.48 | | 0.60 | | |
| D | 6.00 | | 6.20 | | |
| D1 | 4.95 | 5.10 | 5.25 | | |
| E | 6.40 | | 6.60 | | |
| E1 | 4.60 | 4.70 | 4.80 | | |
| е | 2.16 | 2.28 | 2.40 | | |
| e1 | 4.40 | | 4.60 | | |
| Н | 9.35 | | 10.10 | | |
| L | 1.00 | | 1.50 | | |
| (L1) | 2.60 | 2.80 | 3.00 | | |
| L2 | 0.65 | 0.80 | 0.95 | | |
| L4 | 0.60 | | 1.00 | | |
| R | | 0.20 | | | |
| V2 | 0° | | 8° | | |

10/18 DocID030757 Rev 1



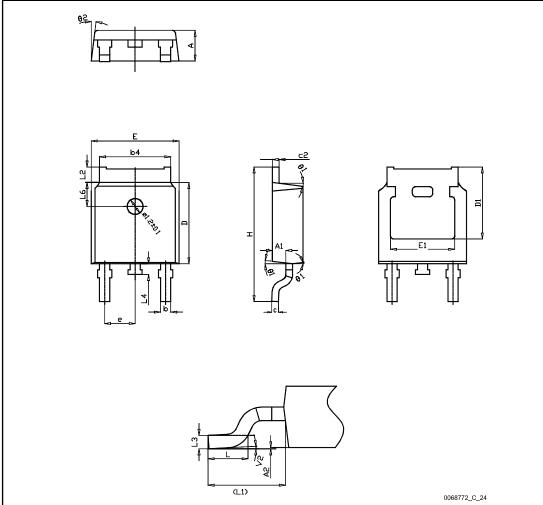
Package information





4.2 DPAK (TO-252) type C package information







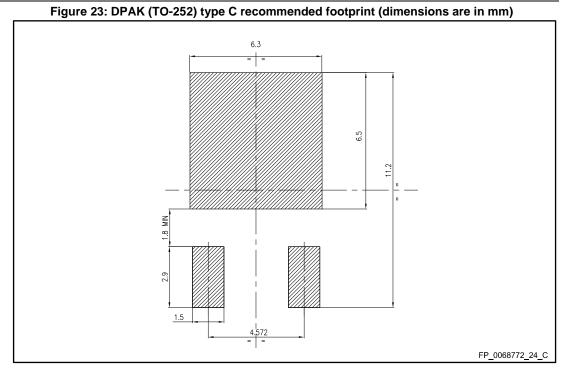
Package information

| DM2 | | Package information | | | | |
|-------|----------------------|----------------------------|-------|--|--|--|
| | Table 10: DPAK (TO-2 | 52) type C mechanical data | 3 | | | |
| Dim. | | mm | | | | |
| Dini. | Min. | Тур. | Max. | | | |
| А | 2.20 | 2.30 | 2.38 | | | |
| A1 | 0.90 | 1.01 | 1.10 | | | |
| A2 | 0.00 | | 0.10 | | | |
| b | 0.72 | | 0.85 | | | |
| b4 | 5.13 | 5.33 | 5.46 | | | |
| С | 0.47 | | 0.60 | | | |
| c2 | 0.47 | | 0.60 | | | |
| D | 6.00 | 6.10 | 6.20 | | | |
| D1 | 5.25 | | | | | |
| E | 6.50 | 6.60 | 6.70 | | | |
| E1 | 4.70 | | | | | |
| е | 2.186 | 2.286 | 2.386 | | | |
| Н | 9.80 | 10.10 | 10.40 | | | |
| L | 1.40 | 1.50 | 1.70 | | | |
| L1 | | 2.90 REF | | | | |
| L2 | 0.90 | | 1.25 | | | |
| L3 | | 0.51 BSC | | | | |
| L4 | 0.60 | 0.80 | 1.00 | | | |
| L6 | | 1.80 BSC | | | | |
| θ1 | 5° | 7° | 9° | | | |
| θ2 | 5° | 7° | 9° | | | |
| V2 | 0° | | 8° | | | |



Package information

STD6N60DM2



14/18



4.3 DPAK (TO-252) packing information

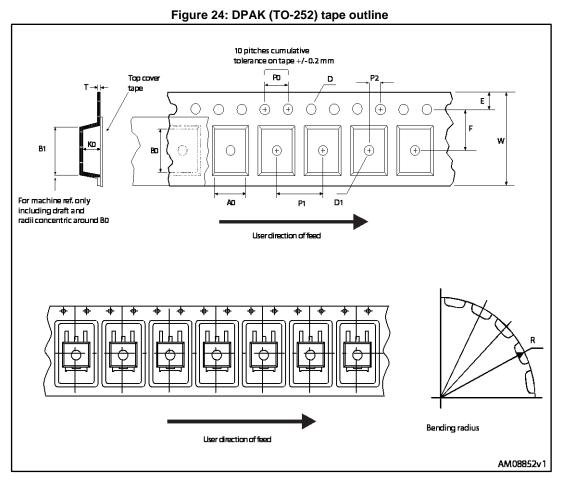
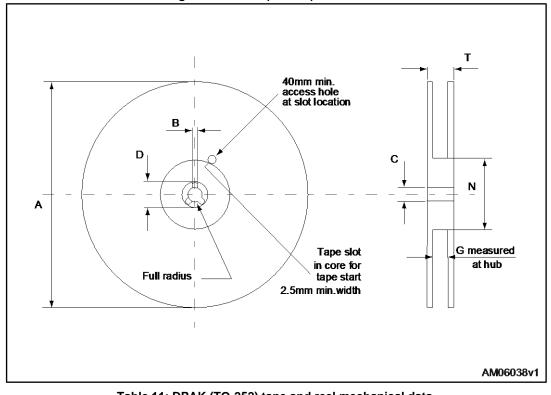




Figure 25: DPAK (TO-252) reel outline



| Table 11: DPAK (TO-252) tape and reel mechanical data | | | | | | | |
|---|------|------|----------------|------|------|--|--|
| Таре | | | Reel | | | | |
| Dim. | mm | | Dim | mm | | | |
| | Min. | Max. | Dim. | Min. | Max. | | |
| A0 | 6.8 | 7 | A | | 330 | | |
| B0 | 10.4 | 10.6 | В | 1.5 | | | |
| B1 | | 12.1 | С | 12.8 | 13.2 | | |
| D | 1.5 | 1.6 | D | 20.2 | | | |
| D1 | 1.5 | | G | 16.4 | 18.4 | | |
| E | 1.65 | 1.85 | Ν | 50 | | | |
| F | 7.4 | 7.6 | Т | | 22.4 | | |
| K0 | 2.55 | 2.75 | | | | | |
| P0 | 3.9 | 4.1 | Base qty. | | 2500 | | |
| P1 | 7.9 | 8.1 | Bulk qty. 2500 | | 2500 | | |
| P2 | 1.9 | 2.1 | | | | | |
| R | 40 | | | | | | |
| Т | 0.25 | 0.35 | | | | | |
| W | 15.7 | 16.3 | | | | | |

. . . .



5 Revision history

Table 12: Document revision history

| Date | Revision | Changes |
|-------------|----------|---------------|
| 26-Jun-2017 | 1 | First release |



IMPORTANT NOTICE – PLEASE READ CAREFULLY

STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, enhancements, modifications, and improvements to ST products and/or to this document at any time without notice. Purchasers should obtain the latest relevant information on ST products before placing orders. ST products are sold pursuant to ST's terms and conditions of sale in place at the time of order acknowledgement.

Purchasers are solely responsible for the choice, selection, and use of ST products and ST assumes no liability for application assistance or the design of Purchasers' products.

No license, express or implied, to any intellectual property right is granted by ST herein.

Resale of ST products with provisions different from the information set forth herein shall void any warranty granted by ST for such product.

ST and the ST logo are trademarks of ST. All other product or service names are the property of their respective owners.

Information in this document supersedes and replaces information previously supplied in any prior versions of this document.

© 2017 STMicroelectronics - All rights reserved

